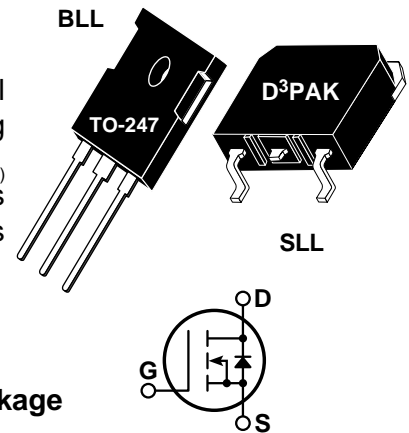


**POWER MOS 7™**

Power MOS 7™ is a new generation of low loss, high voltage, N-Channel enhancement mode power MOSFETS. Both conduction and switching losses are addressed with Power MOS 7™ by significantly lowering  $R_{DS(ON)}$  and  $Q_g$ . Power MOS 7™ combines lower conduction and switching losses along with exceptionally fast switching speeds inherent with APT's patented metal gate structure.

- Lower Input Capacitance
- Lower Miller Capacitance
- Lower Gate Charge,  $Q_g$
- Increased Power Dissipation
- Easier To Drive
- TO-247 or Surface Mount D<sup>3</sup>PAK Package


**MAXIMUM RATINGS**

 All Ratings:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	APT6029	UNIT
$V_{DSS}$	Drain-Source Voltage	600	Volts
$I_D$	Continuous Drain Current @ $T_C = 25^\circ\text{C}$	21	Amps
$I_{DM}$	Pulsed Drain Current <sup>①</sup>	84	
$V_{GS}$	Gate-Source Voltage Continuous	±30	Volts
$V_{GSM}$	Gate-Source Voltage Transient	±40	
$P_D$	Total Power Dissipation @ $T_C = 25^\circ\text{C}$	300	Watts
	Linear Derating Factor	2.4	W/°C
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to 150	°C
$T_L$	Lead Temperature: 0.063" from Case for 10 Sec.	300	
$I_{AR}$	Avalanche Current <sup>①</sup> (Repetitive and Non-Repetitive)	21	Amps
$E_{AR}$	Repetitive Avalanche Energy <sup>①</sup>	30	mJ
$E_{AS}$	Single Pulse Avalanche Energy <sup>④</sup>	1210	

**STATIC ELECTRICAL CHARACTERISTICS**

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$BV_{DSS}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0V, I_D = 250\mu\text{A}$ )	600			Volts
$I_{D(on)}$	On State Drain Current <sup>②</sup> ( $V_{DS} > I_{D(on)} \times R_{DS(on)}$ Max, $V_{GS} = 10V$ )	21			Amps
$R_{DS(on)}$	Drain-Source On-State Resistance <sup>②</sup> ( $V_{GS} = 10V, 0.5 I_{D[Cont.]}$ )			0.29	Ohms
$I_{DSS}$	Zero Gate Voltage Drain Current ( $V_{DS} = V_{DSS}, V_{GS} = 0V$ )			100	μA
	Zero Gate Voltage Drain Current ( $V_{DS} = 0.8 V_{DSS}, V_{GS} = 0V, T_C = 125^\circ\text{C}$ )			500	
$I_{GSS}$	Gate-Source Leakage Current ( $V_{GS} = \pm 30V, V_{DS} = 0V$ )			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage ( $V_{DS} = V_{GS}, I_D = 1mA$ )	3		5	Volts

 **CAUTION:** These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - <http://www.advancedpower.com>

DYNAMIC CHARACTERISTICS

APT6029 BLL - SLL

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V V <sub>DS</sub> = 25V f = 1 MHz		2460		pF
C <sub>oss</sub>	Output Capacitance			440		
C <sub>rss</sub>	Reverse Transfer Capacitance			28		
Q <sub>g</sub>	Total Gate Charge ③	V <sub>GS</sub> = 10V V <sub>DD</sub> = 0.5 V <sub>DSS</sub> I <sub>D</sub> = I <sub>D[Cont.]</sub> @ 25°C		56		nC
Q <sub>gs</sub>	Gate-Source Charge			13		
Q <sub>gd</sub>	Gate-Drain ("Miller") Charge			25		
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> = 15V V <sub>DD</sub> = 0.5 V <sub>DSS</sub> I <sub>D</sub> = I <sub>D[Cont.]</sub> @ 25°C R <sub>G</sub> = 1.6Ω		13		ns
t <sub>r</sub>	Rise Time			10		
t <sub>d(off)</sub>	Turn-off Delay Time			25		
t <sub>f</sub>	Fall Time			8		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I <sub>S</sub>	Continuous Source Current (Body Diode)			21	Amps
I <sub>SM</sub>	Pulsed Source Current ① (Body Diode)			84	
V <sub>SD</sub>	Diode Forward Voltage ② (V <sub>GS</sub> = 0V, I <sub>S</sub> = -I <sub>D[Cont.]</sub> )			1.3	Volts
t <sub>rr</sub>	Reverse Recovery Time (I <sub>S</sub> = -I <sub>D[Cont.]</sub> , di <sub>S</sub> /dt = 100A/μs)		450		ns
Q <sub>rr</sub>	Reverse Recovery Charge (I <sub>S</sub> = -I <sub>D[Cont.]</sub> , di <sub>S</sub> /dt = 100A/μs)		8.0		μC
dv/dt	Peak Diode Recovery dv/dt ⑤			8	V/ns

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
R <sub>θJC</sub>	Junction to Case			0.42	°C/W
R <sub>θJA</sub>	Junction to Ambient			40	

① Repetitive Rating: Pulse width limited by maximum junction temperature.

② Pulse Test: Pulse width < 380 μs, Duty Cycle < 2%

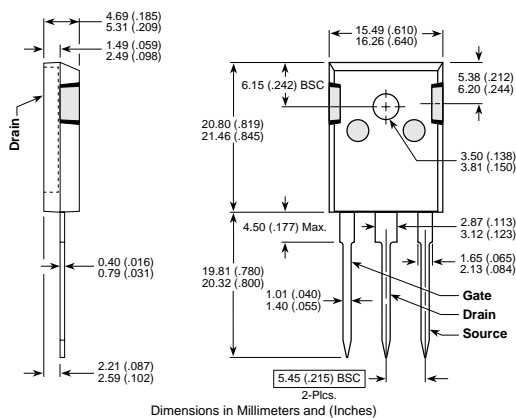
③ See MIL-STD-750 Method 3471

④ Starting T<sub>J</sub> = +25°C, L = 5.49mH, R<sub>G</sub> = 25Ω, Peak I<sub>L</sub> = 21A

⑤ dv/dt numbers reflect the limitations of the test circuit rather than the device itself. I<sub>S</sub> ≤ -I<sub>D[Cont.]</sub>, di<sub>S</sub>/dt ≤ 700A/μs, V<sub>R</sub> ≤ V<sub>DSS</sub>, T<sub>J</sub> ≤ 150°C

APT Reserves the right to change, without notice, the specifications and information contained herein.

TO-247 Package Outline



D<sup>3</sup>PAK Package Outline

